

### N-Channel 60V, 1800mΩ Typ. Power MOSFET

### **Description**

#### **Features**

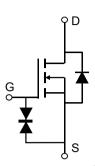
• 60V, 0.3A

$$R_{DS(ON)}$$
 Typ = 1800m $\Omega$  @  $V_{GS}$  = 10 $V$ 

$$R_{DS(ON)}$$
 Typ = 2000m $\Omega$  @  $V_{GS}$  = 4.5V

- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead Free

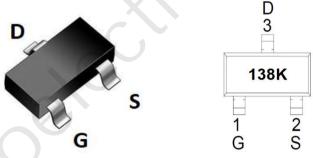
• ESD Protected: 2KV







- Load Switch
- PWM Application
- Power Management



**Marking and Pin Assignment** 

## Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMLTL138K	138K	SOT-23	TAPING	7"	3000	120000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		60	V
$V_{GS}$	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T <sub>A</sub> = 25°C	0.3	Α
I <sub>D</sub>	Continuous Dialii Current	T <sub>A</sub> = 100°C	0.18	Α
I <sub>DM</sub>	Pulsed Drain Current (1)		1.2	Α
$P_{D}$	Power Dissipation	T <sub>A</sub> = 25°C	0.35	W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient <sup>(2)</sup>		357	°C/W
$T_J,T_STG$	Junction & Storage Temperature Range		-55 to 150	°C

# CRMLTL138K

# N-Channel 60V, 1800mΩ Typ. Power MOSFET

### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Char	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±10	μА
On Char	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.7	1.1	1.5	V
В		$V_{GS} = 10V, I_D = 0.3A$	-	1800	2200	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 4.5V, I_D = 0.2A$	-	2000	3000	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance		-	22	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	<b>X</b> -	3.4	-	pF
$C_{rss}$	Reverse Transfer Capacitance	1 - 11VII 12		2.3	-	pF
$Q_g$	Total Gate Charge		<u></u> -	1.6	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 4.5V$ $V_{DS} = 10V, I_{D} = 0.3A$	_	0.2	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> = 10V, 1 <sub>D</sub> = 0.0A	-	0.5	-	nC
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime	.(0)	-	2	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 10V$	-	14	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D$ = 0.2A, $R_{GEN}$ = 10 $\Omega$	-	6	-	ns
$t_{f}$	Turn-Off Fall Time		-	19	-	ns
Drain-So	urce Diode Characteristics and I	Max Ratings				
I <sub>S</sub>	Maximum Continuous Drain to Source D	liode Forward Current	-	-	0.3	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	1.2	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 0.3A$	_	_	1.2	V

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $R_{\text{\tiny BJA}}$  is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

### N-Channel 60V, 1800mΩ Typ. Power MOSFET

# **Typical Performance Characteristics**

Figure 1: Output Characteristics

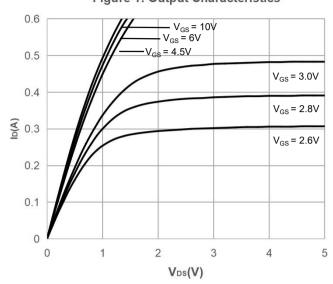


Figure 3: On-resistance vs. Drain Current

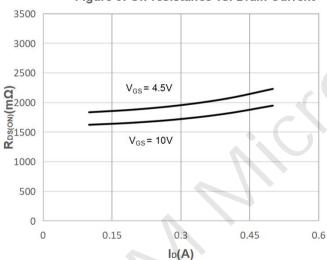


Figure 5: Gate Charge Characteristics

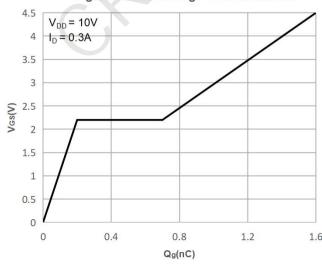


Figure 2: Typical Transfer Characteristics

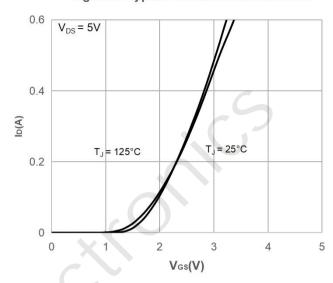


Figure 4: Body Diode Characteristics

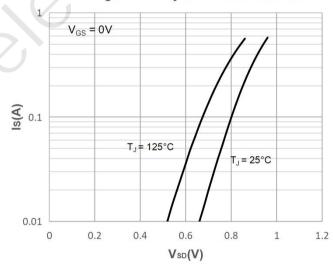
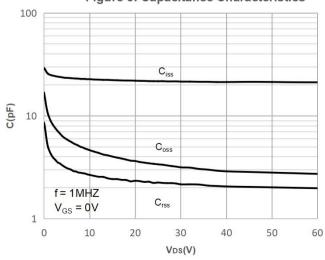


Figure 6: Capacitance Characteristics





# **Typical Performance Characteristics**

Figure 7: Normalized Breakdown voltage vs.

Junction Temperature

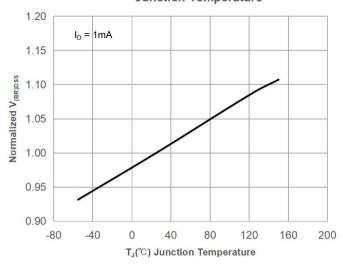
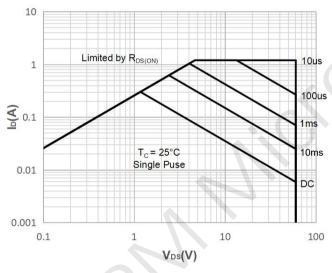


Figure 9: Maximum Safe Operating Area



**Figure 11: Normalized Maximum Transient** 

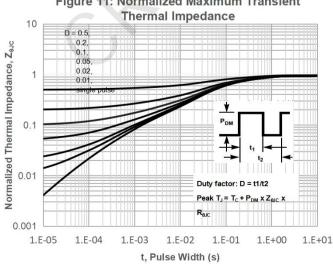


Figure 8: Normalized on Resistance vs. Junction Temperature

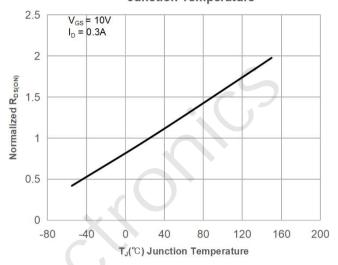


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

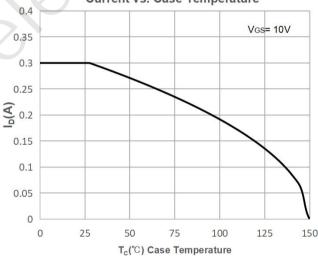
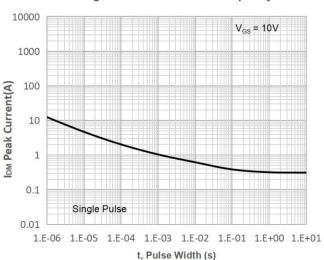


Figure 12: Peak Current Capacity



Version: 1.2

### N-Channel 60V, 1800mΩ Typ. Power MOSFET

## **Test Circuit**

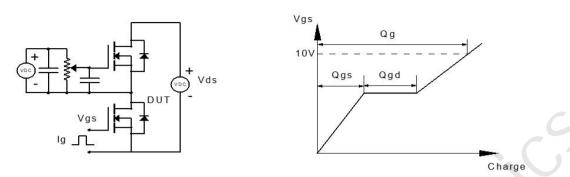


Figure 1: Gate Charge Test Circuit & Waveform

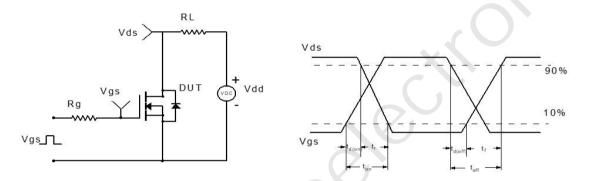


Figure 2: Resistive Switching Test Circuit & Waveform

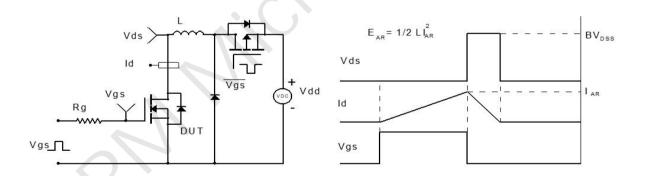


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

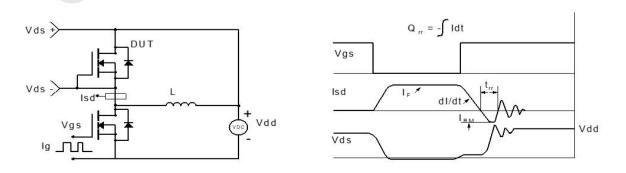
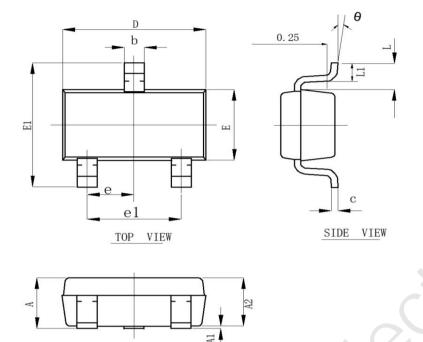


Figure 4: Diode Recovery Test Circuit & Waveform



#### N-Channel 60V, 1800mΩ Typ. Power MOSFET

### Package Mechanical Data(SOT-23)



SIDE VIEW

SYMBOL	MIN	MAX	
A	0.900	1. 150	
A1	0.000	0. 100	
A2	0.900	1.050	
b	0. 300	0. 500	
С	0.080	0. 150	
D	2. 800	3. 000	
Е	1. 200	1.400	
E1	2. 250	2,550	
L	0.550 REF.		
θ	0°	8°	
L1	0. 300	0.500	
e	0.950 TYP.		
e <sub>1</sub>	1.800	2.000	

## **Important Notice**

The information presented in datasheets is for reference only. CRM reserves the right to make changes at any time to any products or information herein, without notice.

Customers are responsible for the design and applications, including compliance with all laws, regulations and safety requirements or standards.

"Typical" parameters which provided in datasheets can vary in different applications and actual performance may vary over time. Customers are responsible for doing all necessary testing to minimize the risks associated with their applications and products.

is a registered trademark of Wuxi CRM Microelectronics Co. , Ltd. Copyright ©2023 CRM Microelectronics Co. , Ltd. All rights reserved.

### **Contact information**

For more information, please visit: http://www.crm-semi.tech For sales information, please send an email to: sales@crm-semi.com